**IDW ’23 EXHIBITION APPLICATION FORM**

Send to: IDW ’23 Secretariat

c/o Bilingual Group Ltd.

2F 11-1 Yochomachi, Shinjuku-ku, Tokyo, 162-0055, Japan

E-mail: [idw@idw.or.jp](mailto:idw@idw.or.jp)

**We apply for IDW ’23 Exhibition.**

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| Company Name |  | | | |
| Mailing Address |  | | | |
| Contact Personnel |  | | | |
| Contact Personnel’s Dept. |  | | | |
| Phone Number |  | | | |
| E-mail Address |  | | | |
| Application Date |  | | | |
| Booth Type | □ Regular booth (100,000 JPY/booth) Number of booth: booth (Up to two booth)  □ Benefit booth for new exhibitor (50,000JPY)  □ Metaverse venue only (25,000 JPY)  （Only the company related to metaverse technology or product can apply for this.） | | | |
| Electric Power | W | | (standard specification: 2 Type-A sockets with 500W, 15A) | |
| Number of chairs in need |  | | (Standard: 1) Requests may not be accepted on occasion. | |
| Metaverse Exhibition | [ ] Yes [ ] No | |  | |
| Bill for the exhibition fee | [ ] Required [ ] Not required | | | |
| Exhibit Item/Contents |  | | | |
| Phone number to be listed on brochure | |  | | |
| E-mail address to be listed on brochure | |  | | |
| Website to be listed on brochure | |  | | |
| Check the box if you do not allow IDW or the Press to be filmed. | | | | □ |
| Please select the fields related to your exhibit contents. (Check all apply.)  □ 3D/Hyper-Realistic Displays □ Active-Matrix Displays □ Display Electronic Systems  □ Emissive Technologies □ e-Paper □ Flexible Electronics □ Interactive Technologies  □ Human Factor □ Liquid Crystal Science and Technologies □ Manufacturing, Process and Equipment  □ Materials and Components □ MEMS □ OLED Displays and Organic Devices  □ Oxide-Semiconductor TFT □ Projection and Large Area Displays  □ User Experience and Cognitive Engineering □ AR/VR and Hyper Reality □ Automotive Displays  □ Micro/Mini LEDs □ Quantum Dot Technologies □ Artificial Intelligence and Smart Society  □ Metaverse System □ DX Sensing and Radiation Imaging □ Image Sensing Technologies  □14th International Conference on Three Dimensional Systems and Applications | | | | |
| Notes |  | | | |